



D3V3M1U2S9

3.3V UNIDIRECTIONAL TVS DIODE

Product Summary

V _{BR min}	I _{pp max}	C _{in typ}
5.0V	12A	70pF

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high-ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripheral

SOD923



Top View

Features

- Provides ESD Protection per IEC 61000-4-2 Standard:
 Air ±30kV, Contact ±30kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOD923
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (3) (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.001 grams (Approximate)



Device Schematic

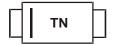
Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D3V3M1U2S9-7	Standard	TN	7	8	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



TN = Product Type Marking Code Line Denotes Pin 1 or Cathode Side

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_PP	120	W	8/20µs, Figure 3
Peak Pulse Current	I _{PP}	12	Α	8/20µs, Figure 3
ESD Protection – Contact Discharge	V _{ESD_Contact}	±30	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V_{ESD_Air}	±30	kV	IEC 61000-4-2 Standard



Thermal Characteristics

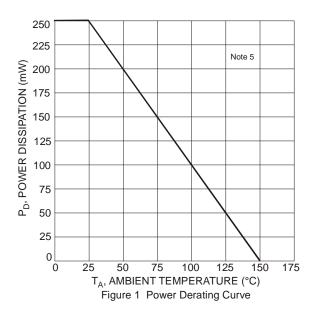
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ hetaJA}$	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

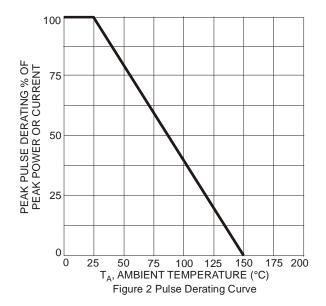
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V _{RWM}	_	_	3.3	V	_
Channel Leakage Current (Note 6)	I _{RM}	_	_	2.0	μA	V _{RWM} = 3.3V
Clamping Voltage, IEC 61000-4-5	V _{CL}	_	_	8	V	$I_{PP} = 1A$, $tp = 8/20 \mu S$
		_	_	10		$I_{PP} = 12A$, $tp = 8/20\mu S$
Breakdown Voltage	V_{BR}	5.0	_	_	V	$I_R = 1mA$
Channel Input Capacitance	C _T	_	70	80	pF	$V_R = 0V$, $f = 1MHz$

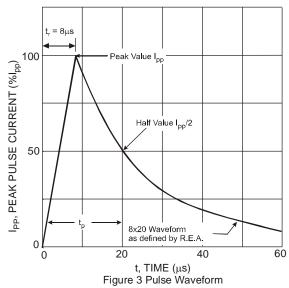
Notes:

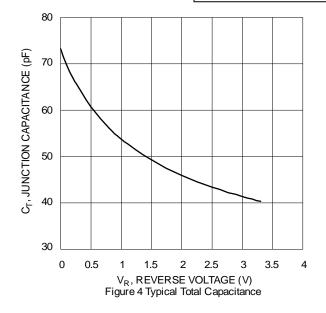
- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.







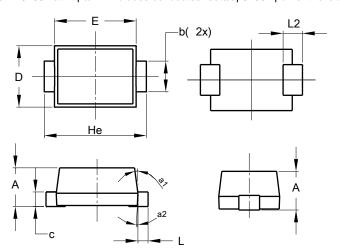






Package Outline Dimensions

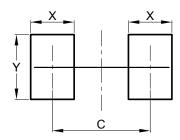
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOD923						
(0.	(0.3mm Lead Width)					
Dim	Min	Max	Тур			
Α	0.34	0.40	0.37			
b	0.25	0.35	0.30			
С	0.05	0.15	0.10			
D	0.55	0.65	0.60			
E	0.75	0.85	0.80			
He	0.95	1.05	1.00			
L	0.05	0.15	0.10			
L2	0.190 REF					
a1	0°	8°	7°			
a2	2°	4°	3°			
All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)		
С	0.900		
Х	0.400		
Υ	0.600		



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